



18V ULTRA LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

Product Summary

VBR (I	Min)	IPP (Max)	Ст (Тур)
19\	/	1A	0.3pF

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Applications

- Cellular handsets
- Portable electronics
- Computers and peripherals

Features

- Low Profile Package (0.53mm Max) and Ultra-Small PCB Footprint Area (1.08mm * 0.68mm Max) Suitable for Compact Portable Electronics
- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±15kV, Contact ±14kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An Automotive-Compliant Part is Available Under Separate
 Datasheet (DESD18VF1BLQ)

Mechanical Data

- Package: X1-DFN1006-2
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @
- Weight: 0.001 grams (Approximate)



X1-DFN1006-2

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Device Schematic

Ordering Information (Note 4)

Part Number	Deekere	Marking	Deal Size (inches)	Tone Width (mm)	Packing	
Part Number	Package	Marking	Reel Size (inches)	Tape Width (mm)	Qty.	Carrier
DESD18VF1BL-7B	X1-DFN1006-2	RM	7	8	10,000	Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:



RM = Product Type Marking Code RM is Assembled in Shanghai RM is Assembled in Chengdu Bar Denotes Pin 1



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	IPP	1	А	8/20µs
ESD Protection – Contact Discharge	Vesd_contact	±14	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	Vesd_air	±15	kV	IEC 61000-4-2 Standard

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Package Power Dissipation (Note 5)	PD	250	mW	
Thermal Resistance, Junction to Ambient (Note 5)	Reja	500	°C/W	
Operating and Storage Temperature Range	TJ, TSTG	-65 to +150	°C	

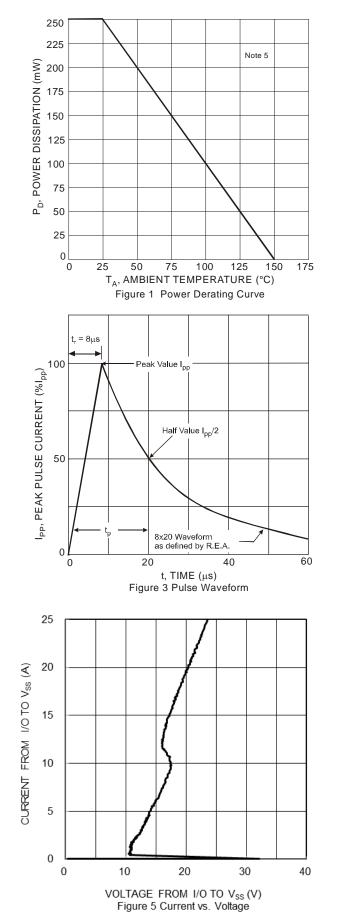
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

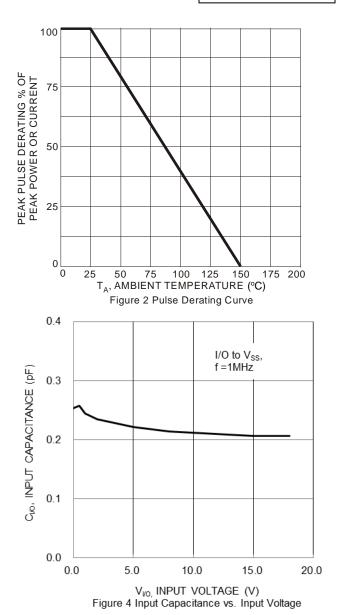
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	Vrwm	_	_	18	V	—
Reverse Current (Note 6)	IR	_	1	30	nA	V _R = 18V
Reverse Breakdown Voltage	VBR	19	22	25	V	I _R = 1mA
Reverse Clamping Voltage	VCL1	_	17	_	V	ITLP = 16A, tP = 100ns
Reverse Clamping Voltage	VCL2	_	_	17	V	IPP = 1A, tP = 8/20µs
Dynamic Resistance	Rdyn	_	0.5	_	Ω	TLP, 10A, t _P = 100ns
Capacitance	Ст	_	0.3	0.45	pF	$V_R = 0V, f = 1MHz$

Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

6. Short duration pulse test used to minimize self-heating effect.





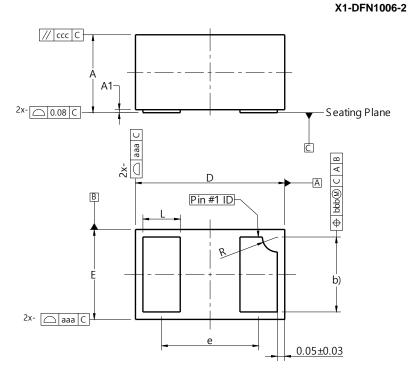


DESD18VF1BL Document number: DS42367 Rev. 2 - 2



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

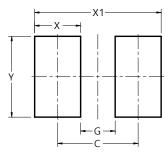


	X1-DFN1006-2					
Dim	Min	Max	Тур			
Α	0.47	0.53	0.50			
A1	0.00	0.05	0.03			
b	0.45	0.55	0.50			
D	0.95	1.075	1.00			
Е	0.55	0.675	0.60			
е			0.65			
L	0.20	0.30	0.25			
R	0.05	0.15	0.10			
aaa	0.15					
bbb	0.05					
CCC	0.05					
All	Dimen	sions in	mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-2



Dimensions	Value (in mm)		
С	0.70		
G	0.30		
Х	0.40		
X1	1.10		
Y	0.70		



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